2020

Panasonic INDUSTRY

Conductive Polymer Aluminum Electrolytic Capacitors

Products Catalog



Guidelines and precautions regarding the technical information and use of our products described in this online catalog.

- If you want to use our products described in this online catalog for applications requiring special qualities or reliability, or for applications where the failure or malfunction of the products may directly jeopardize human life or potentially cause personal injury (e.g. aircraft and aerospace equipment, traffic and transportation equipment, combustion equipment, medical equipment, accident prevention, anti-crime equipment, and/or safety equipment), it is necessary to verify whether the specifications of our products fit to such applications. Please ensure that you will ask and check with our inquiry desk as to whether the specifications of our products fit to such applications use before you use our products.
- The quality and performance of our products as described in this online catalog only apply to our products when used in isolation. Therefore, please ensure you evaluate and verify our products under the specific circumstances in which our products are assembled in your own products and in which our products will actually be used.
- If you use our products in equipment that requires a high degree of reliability, regardless of the application, it is recommended that you set up protection circuits and redundancy circuits in order to ensure safety of your equipment.
- The products and product specifications described in this online catalog are subject to change for improvement without prior notice. Therefore, please be sure to request and confirm the latest product specifications which explain the specifications of our products in detail, before you finalize the design of your applications, purchase, or use our products.
- The technical information in this online catalog provides examples of our products' typical operations and application circuits. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, right, or interest in our intellectual property.
- If any of our products, product specifications and/or technical information in this online catalog is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially with regard to security and export control, shall be observed.

< Regarding the Certificate of Compliance with the EU RoHS Directive/REACH Regulations>

- The switchover date for compliance with the RoHS Directive/REACH Regulations varies depending on the part number or series of our products.
- When you use the inventory of our products for which it is unclear whether those products are compliant with the RoHS Directive/REACH Regulation, please select "Sales Inquiry" in the website inquiry form and contact us.

We do not take any responsibility for the use of our products outside the scope of the specifications, descriptions, guidelines and precautions described in this online catalog.



Notices

■ Applicable laws and regulations

- •This product complies with the RoHS Directive (Restriction of the use of certain hazardous substances in electrical and electronic equipment (DIRECTIVE 2011/65/EU and (EU)2015/863)).
- No Ozone Depleting Chemicals(ODC's), controlled under the Montreal Protocol Agreement, are used in producing this product.
- We do not use PBBs or PBDEs as brominated flame retardants.
- Export procedure which followed export related regulations, such as foreign exchange and a foreign trade method, on the occasion of export of this product.
- These products are not dangerous goods on the transportation as identified by UN(United Nations) numbers or UN classification.

Limited applications

- This capacitor is designed to be used for electronics circuits such as audio/visual equipment, home appliances, computers and other office equipment, optical equipment, measuring equipment.
- High reliability and safety are required [be / a possibility that incorrect operation of this product may do harm to a human life or property] more. When use is considered by the use, the delivery specifications which suited the use separately need to be exchanged.

■ Intellectual property rights and licenses

• The technical information in this specification provides examples of our products' typical operations and application circuits. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, right, or interest in our intellectual property.

Items to be observed

■ For specification

- This specification guarantees the quality and performance of the product as individual components. The durability differs depending on the environment and the conditions of usage.

 Before use, check and evaluate their compatibility with actual conditions when installed in the products. When safety requirements cannot be satisfied in your technical examination, inform us immediately.
- Do not use the products beyond the specifications described in this document.

Upon application to products where safety is regarded as important

Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment where a defect in these products may cause the loss of human life or other signification damage, such as damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment, electric heating appliances, combustion/ gas equipment, rotating rotating equipment, and disaster/crime prevention equipment.

- (1) The system is equipped with a protection circuit and protection device.
- (2) The system is equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault.

Conditions of use

- Before using the products, carefully check the effects on their quality and performance, and determined whether or not they can be used. These products are designed and manufactured for general-purpose and standard use in general electronic equipment. These products are not intended for use in the following special conditions.
 - (1) In liquid, such as Water, Oil, Chemicals, or Organic solvent.
 - (2) In direct sunlight, outdoors, or in dust.
 - (3) In vapor, such as dew condensation water of resistive element, or water leakage, salty air, or air with a high concentration corrosive gas, such as Cl₂, H₂S, NH₃, SO₂, or NO_x.
 - (4) In an environment where strong static electricity or electromagnetic waves exist.
 - (5) Mounting or placing heat-generating components or inflammables, such as vinyl-coated wires, near these products.
 - (6) Sealing or coating of these products or a printed circuit board on which these products are mounted, with resin and other material.
 - (7) Using resolvent, water or water-soluble cleaner for flux cleaning agent after soldering. (In particular, when using water or a water-soluble cleaning agent, be careful not to leave water residues)
 - (8) Using in the atmosphere where strays acid or alkaline.
 - (9) Using in the atmosphere where there are excessive vibration and shock.
- Please arrange circuit design for preventing impulse or transitional voltage.
 Do not apply voltage, which exceeds the full rated voltage when the capacitors receive impulse voltage, instantaneous high voltage, high pulse voltage etc.
- Our products there is a product are using an electrolyte solution. Therefore, misuse can result in rapid deterioration of characteristics and functions of each product. Electrolyte leakage damages printed circuit and affects performance, characteristics, and functions of customer system.



Application Guidelines (SP-Cap)

1. Circuit design

1.1 Prohibited circuits for use

Do not use the SP-Cap with the following circuit.

- (1) High-impedance voltage retention circuits
- (2) Coupling circuits
- (3) Time-constant circuit
- (4) Circuit which are greatly affected by leakage current
- (5) 2 or more SP-Cap connected serially

1.2 Voltage and polarity

The application of over- voltage and reverse voltage described below can cause increases in leakage current and short circuits. Applied voltage, refers to the voltage value including the peak value of the transitional Instantaneous voltage and the peak value of ripple voltage, not just steady line voltage.

Design your circuit so than the peak voltage does not exceed the stipulated voltage.

[Over-Voltage]

Do not apply over-voltage in excess of the rated voltage. Do not apply voltage, which exceeds the full rated voltage when the SP-Cap receive impulse voltage, instantaneous high voltage, high pulse voltage etc.

[Reverse-Voltage]

Do not apply reverse-voltage

1.3 Ripple current

Use the SP-Cap within the stipulated permitted ripple current.

When excessive ripple current is applied to the SP-Cap, if causes increases in leakage current and short circuits due to self-heating.

Even when using the SP-Cap under the permissible ripple current, reverse voltage may occur if the DC bias voltage is low.

1.4 Leakage current

There is a risk of leakage current characteristics increasing even if the following use environments are within the stipulated range. However, even if the leakage current increases, the SP-Cap self-repairing function will reduce the leakage current in most cases when a voltage is applied.

- (1) After reflow
- (2) Shelf conditions such as high temperature with no load, high temperature high humidity with no load and sudden temperature changes.

1.5 Temperature

(1) Use at or under the rated (guaranteed) temperature.

Operation at temperatures exceeding specifications causes large changes in the SP-Cap electrical properties, and deterioration than can potentially lead to failure.

When calculating the operating temperature of the SP-Cap, be sure to include not only the ambient temperature and internal temperature of the unit, but also radiation from heat generating elements inside the unit (power transistors, resistors, etc.), and self-heating due to ripple current.

(2) Specified ESR is a value at the time of shipping from factory. ESR may change upon use conditions.

1.6 Failure rate

The majority of failure modes are short circuits or increases in leakage current.

The main factors of failure are mechanical stress, heat stress and electric stress due to re-flow and heat from the use temperature environment.

Even within the stipulated limits, it is possible to lower the failure rate by reducing use conditions such as temperature and voltage. Please be sure to have ample margin in your design.

[Expected Failure Rate]

- (a) Date based on our reliability tests: 8.2 Fit or less (Based on applied rated voltage at 105 °C)
- (b) Market failure rate: 0.13 Fit or less (Based on c=0, Reliability standard: 60 %)

1.7 Mounting area consideration

Isolate the surface of PCB under the mounted SP-Cap.

2. Mounting

2.1 When mounting

- (1) Check the SP-Cap ratings (capacitance and voltage) before mounting.
- (2) Check the SP-Cap polarity before mounting.
- (3) Check the land size for the SP-Cap before mounting.
- (4) When using a mounter, if the pressure for mounting is too high, then the current leak may increase, shortcircuiting may occur, or the SP-Cap may break down or come off.

2.2 Soldering

(1) Reflow soldering

Be performed by one of following methods.

(a) Ambient heat conduction reflow (IR / Hot-air)

Please refer to the page of "Mounting Specifications".

(b) Vapor phase reflow (but only allowable for CX, CT, SX, ST, GX, LX, LT and HX series). Please contact Panasonic for details of allowable vapor phase reflow condition.

(2) Wave soldering and dip soldering

Please remind SP-Cap is NOT compatible.

(3) Hand soldering

Excessive force stress to the SP-Cap should be avoided

Conditions

Tip temperature of soldering iron : 350 °C max. Exposure time : 10 s max.

* Once removed from the printed circuit board for any reason, please do not use the SP-Cap again.

2.3 Land size

Refer to the land size of "Mounting specifications" for appropriate design dimensions.

Circuit board design requires examination of the most suitable dimensions taking conditions such as circuit board, parts and reflow into consideration.

2.4 Mechanical stress

Do not apply excessive force to the SP-Cap this can damage the electrodes and badly affect the SP-Cap mount ability. It can also cause the increase of leakage current, separation of the lead wire and element, and damage to the SP-Cap body, all of which can badly affect the electrical performance of the SP-Cap.

2.5 Circuit board cleaning

 $\ensuremath{\mathsf{SP-Cap}}$ should be cleaned after soldering in accordance with the following conditions.

Temperature : Less than 60 °C Time : Within 5min

Be sure to sufficiently wash and dry (20 min at 100 $^{\circ}$ C) the board afterward.

[Recommended Cleaning Solvents]

Pine Alpha ST-100S, Clean-thru 750H / 750L / 710M, Aqua Cleaner 210SEP, Sunelec B-12 DK Beclear CW-5790, Techno Cleaner 219, Cold Cleaner P3-375, Telpene Cleaner EC-7R Technocare FRW-17 / FRW-1 / FRV-1, AXREL 32, IPA (Isopropyl alcohol)

- (1) Consult our factory when performing processes with cleaning solvents other than those listed above or deionized water.
- (2) The use of ozone depleting cleaning agents are not recommended in the interest of protecting the environment.
- (3) In the case of using ultrasonic cleaning, the terminals may be broken. Therefore, please test before using in mass production.

3. Usage environment of equipment

Avoid using equipment to which SP-Cap are fi ted in the following environments.

- (1) In liquid, such as Water, Oil, Chemicals, or Organic solvent.
- (2) In direct sunlight, outdoors, or in dust.
- (3) In vapor, such as dew condensation water of resistive element, or water leakage, salty air, or air with a high concentration corrosive gas, such as Cl2, H2S, NH3, SO2, or NO2.
- (4) In an environment where strong static electricity or electromagnetic waves exist.
- (5) Mounting or placing heat-generating components or inflammables, such as vinyl-coated wires, near these SP-Cap.
- (6) Sealing or coating of these SP-Cap or a printed circuit board on which these SP-Cap are mounted, with resin and other material.
- (7) Acid or alkaline environments.
- (8) Environment subject to excessive vibration and shock.



4. Storage

SP-Cap should be stored in a moisture proof environment. Storage conditions before and after opening the moisture proof packaging as follows.

(If these conditions are exceeded, the package may absorb moisture and there is a risk of damage to the exterior due to heat stress during mounting.)

[Environment of Storage]

Temperature : $5 \, ^{\circ} \text{C}$ to $30 \, ^{\circ} \text{C}$ Humidity : Less than 70 %

Maximum storage term before opening the package : 2 years after manufactured

Maximum storage condition after opening the package : 7 days after opening

SP-Cap should be all used within the storage term after opening the package.

5. Transportation

Take sufficient care during handling because excessive vibration, or shock can cause the reliability of the SP-Cap to decrease.

6. Emergency procedures

If the SP-Cap is overheated, the resin case may emit smoke. If this occurs, immediately switch off the unit's main power supply to stop operation. Keep your face and hands away from the SP-Cap the temperature may be high enough to cause the SP-Cap to ignite and burn.

7. Discarding

Since SP-Cap are composed of various metals and resins, treat them as industrial waste when arranging for their disposal.

The precautions in using aluminum electrolytic capacitors follow the "Safety application guide for the use in fixed aluminum electrolytic capacitors for electronic equipment", RCR-2367D issued by JEITA in October 2017.

Please refer to the above application guide for details.

* Intellectual property right

We, Panasonic Group are providing the product and service that customers can use without anxiety, working positively on the protection of our products under intellectual property rights.

Representative patents relating to SP-Cap are as follows:

US Patent No. 7136276



	Line up											
Series	PArt No.	Feature	Low profile	Low ESR	Low ESL	High voltage	High temp.	Category temperature (℃)	Rated voltage (V)	ESR (mΩ)	Capacitance (μF)	Size (mm) LxW 7.3x4.3
CX	EEFCX					•		-55 to 105	2 to 35	12 to 40	15 to 560	1.9
СТ	EEFCT	Standard	•			•		-55 to 105	4 to 35	15 to 40	15 to 180	1.4
CS	EEFCS		•			•		-55 to 105	4 to 35	15 to 40	10 to 120	1.1
SX	EEFSX	Low ESR		•				-55 to 105	2 to 6.3	4.5 to 9	82 to 560	1.9
GX	EEFGX	Super low ESR High ripple current		•	•			-55 to 105	2 to 2.5	3	330 to 560	1.9
LX	EEFLX	Low ESR · Low ESL		•	•			-55 to 105	2 to 2.5	4.5 to 6	330 to 560	1.9
ST	EEFST	Low profile · Low ESR	•	•				-55 to 105	2 to 2.5	6	270 to 330	1.4
LT	EEFLT	Low profile Low ESR · Low ESL	•	•	•			-55 to 105	2 to 2.5	6	270 to 330	1.4
SS	EEFSS	Low profile · Low ESR	•	•				-55 to 105	2 to 2.5	6	180 to 220	1.1
LS	EEFLS	Low profile Low ESR · Low ESL	•	•	•			-55 to 105	2 to 2.5	6	180 to 220	1.1
SR	EEFSR	Low profile (1.0 mm max.) Low ESR	•	•				-55 to 105	2 to 6.3	4.5 to 9	68 to 220	1.0 max.
LR	EEFLR	Low profile (1.0 mm max.) Low ESR • Low ESL	•	•	•			-55 to 105	2 to 6.3	4.5 to 9	68 to 220	1.0 max.
GY	EEFGY	Super low ESR High ripple current Height 3.0 mm max.		•				-55 to 105	2 ~ 2.5	3	680 to 820	2.8
CY	ECGCY	Guaranteed at 85 ℃		•				-55 to 85	4, 6.3	15	330 to 470	2.8
SY	ECGSY	Height 3.0 mm max.		•				-55 to 85	4, 6.3	9	330 to 470	2.8
НХ	EEFHX	Guaranteed at 125 ℃		•		•	•	-55 to 125	2 to 25	4.5 to 40	15 to 560	1.9



CS, CT, CX and HX series part numbers rated 10 V.DC or above are Not Recommended For New Design.



Diagram

2-terminals

Standard

CX Series

Size(mm): $7.3 \times 4.3 \times 1.9$ V/ μ F : 2/560 to 35/22 ESR(m Ω): 12 to 40

> Low profile

CT Series

Size(mm): $7.3 \times 4.3 \times 1.4$ V/ μ F : 4/180 to 35/15

 $ESR(m\Omega): 15/40$



CS Series

Size(mm): $7.3 \times 4.3 \times 1.1$ V/µF : 4/120 to 35/10

 $ESR(m\Omega): 15/40$

Guaranteed at 85℃

CY/SY Series

Size(mm): $7.3 \times 4.3 \times 2.8$ V/ μ F : 4/470 to 6.3/330

 $ESR(m\Omega): 9/15$

Guaranteed at 125℃

HX Series

Size(mm): $7.3 \times 4.3 \times 1.9$ V/ μ F : 2/560 to 25/33

 $ESR(m\Omega)$: 4.5 to 40

Low ESR

NEW

GY Series

Size(mm): 7.3 x 4.3 x 2.8 V/μF : 2/820 to 2.5/680

 $ESR(m\Omega): 3$



GX Series

Size(mm): $7.3 \times 4.3 \times 1.9$ V/ μ F : 2/560 to 2.5/470

 $ESR(m\Omega): 3$

Super low FSR

SX Series

Size(mm): $7.3 \times 4.3 \times 1.9$ V/ μ F : 2/560 to 6.3/220

 $ESR(m\Omega)$: 4.5 to 9

Low profile

ST Series

Size(mm): $7.3 \times 4.3 \times 1.4$ V/ μ F : 2/330 to 2.5/270

 $ESR(m\Omega): 6$



SS Series

Size(mm): $7.3 \times 4.3 \times 1.1$ V/ μ F : 2/220 to 2.5/180

 $ESR(m\Omega): 6$



SR Series

Size(mm): 7.3 x 4.3 x 1.0(max.)

V/μF : 2/220 to 6.3/68

 $ESR(m\Omega)$: 4.5 to 9

3-terminals

Low ESR/Low ESL*

GX-L Series

Size(mm): $7.3 \times 4.3 \times 1.9$ V/ μ F : 2/560 to 2.5/470

 $ESR(m\Omega): 3$

Super low ESR

LX Series

Size(mm): $7.3 \times 4.3 \times 1.9$ V/ μ F : 2/560 to 2.5/470

 $ESR(m\Omega): 4.5/6$

Low profile

LT Series

Size(mm): $7.3 \times 4.3 \times 1.4$ V/µF : 2/330 to 2.5/270

 $ESR(m\Omega)$: 6



LS Series

Size(mm): $7.3 \times 4.3 \times 1.1$ V/ μ F : 2/220 to 2.5/180

 $ESR(m\Omega)$: 6



LR Series

Size(mm): 7.3 x 4.3 x 1.0(max.)

 $V/\mu F$: 2/220 to 6.3/68

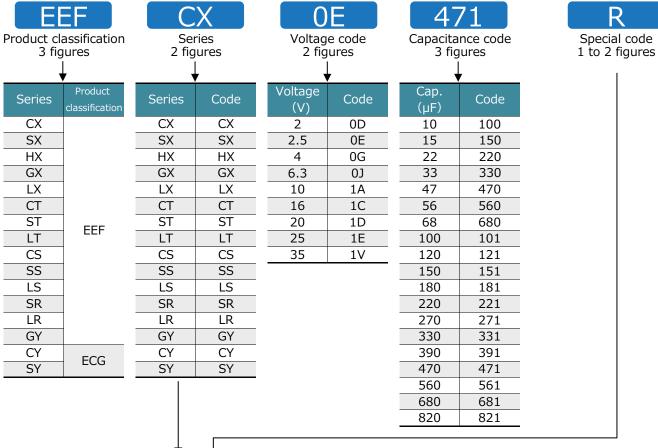
 $ESR(m\Omega)$: 4.5 to 9

*ESL: 0.5nH (Typ.)



Explanation of part numbers

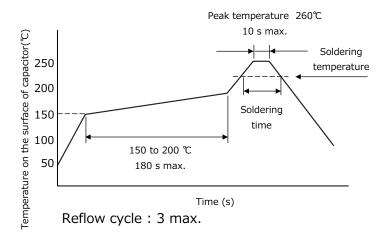
♦ Part number system



	*	<u> </u>			
Height	Series	Special	ESR (mΩ max.)	Term	ninals
(mm)	Series	code	LSIX (IIIsz IIIdx.)	2	3
	CX	R	15 (to 6.3 V), 40 (10 V to 35 V)	0	
	CX	XR	12	0	
		ER	9	0	
	SX	E7	7	0	
	5/	XE	6	0	
		E4	4.5	0	
1.9 ± 0.1		R	15 (to 2.5 V), 40 (10 V to 25 V)	0	
1.9 ± 0.1	Ц∨	R9	9	0	
	HX	R6	6	0	
		R4	4.5	0	
	GX	R	3	0	
	GΛ	L	3		0
	LX	R	6		0
	LX	R4	4.5		0
	CT	R	15 (to 6.3 V), 40 (10 V to 35 V)	0	
1.4 ± 0.1	ST	R	6	0	
	LT	R	6		0
	CS	R	15 (to 6.3 V), 40 (10 V to 35 V)	0	
1.1 ± 0.1	SS	R	6	0	
	LS	R	6		0
	SR	R	6 (to 2.5 V), 9 (4 V to 6.3 V)	0	
1.0 (may)	SK	R4	4.5	0	
1.0 (max.)	LR	R	6 (to 2.5 V), 9 (4 V to 6.3 V)		0
	LN	R4	4.5		0
	GY	R	3	0	
2.8 ± 0.2	CY	R	15	0	
	SY	R	9	0	

Mounting specification

Recommendable reflow soldering

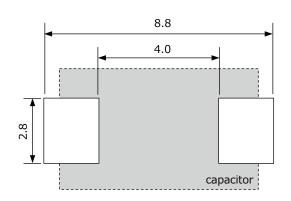


Soldering temperature and soldering time

Temperature	Time
≥ 255℃	30 s max.
≥ 230°C	130 s max.
≥ 217℃	150 s max.

SP-Cap recommended profile condition of the IPC/J-STD-020D standard

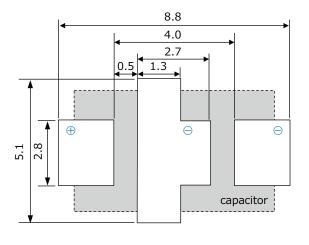
- Typical land pattern
 - \square 2-terminals For standard terminal (C*, S*, G*, HX series)

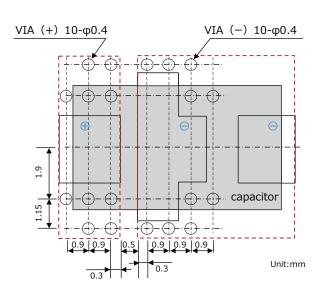


Unit:mm

 \square 3-terminals For low ESL terminal (L*, GX-L series)

⟨VIA⟩
For low ESL terminal (L*, GX-L series)

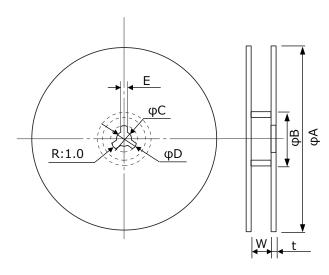






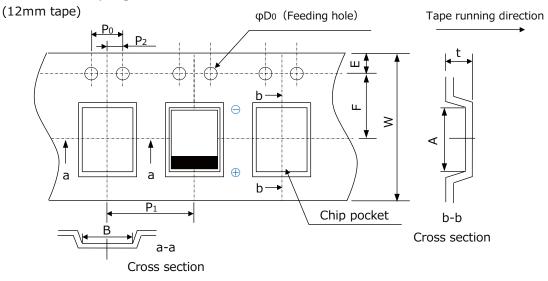
Packaging specifications

• Reel dimensions



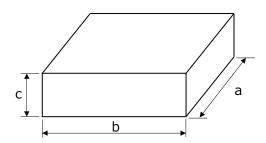
						Uni	it:mm
Reel	φА	φВ	φС	φD	Е	W	t
φ330	330	80	13±0.5	21±0.8	2±0.5	14	3
φ180	180	60	13±0.5	21±0.8	2±0.5	14	3

Embossed taping



А	В	W	F	Е	P1	
7.6±0.2	4.5±0.2	12±0.3	5.5±0.1	1.75±0.1	8.0±0.1	
P ₂	Do	(D0)	Upper row : Product height / Lower berth : t			
P2	P0	φD0	to 1.1	1.4 to 1.9	2.8	
2.0±0.1	4.0±0.1	$1.5 {}^{+0.1}_{0}$	1.5±0.2	2.4±0.2	3.5±0.2	

Packaging box dimensions



			Unit:min
Reel	a	b	С
φ330	400 max.	400 max.	135 max.
φ180	320 max.	240 max.	135 max.



Surface Mount Type CS,CT,CX series

CS, CT and CX series part numbers rated 10 V.DC or above are Not Recommended.
For New Design.



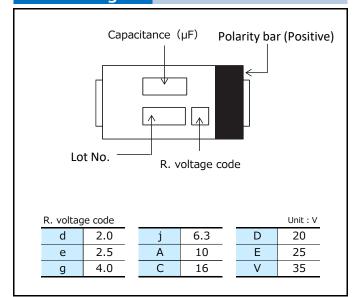
SP-Cap

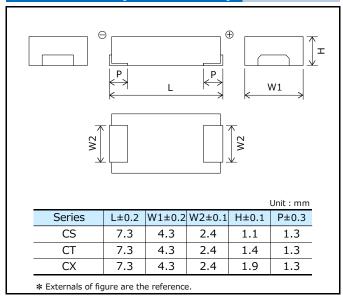
Features

- High voltage (35 V max.)
- Low profile (Height 1.0 mm max.)
- High ripple current (5600 mA rms max.)
- RoHS compliance, Halogen free

Specifications							
Series	CS	СТ		CX			
Category temp. range		-55 ℃ to	+105 ℃				
Rated voltage range	4.	0 V to 35 V		2.0 V	to 35 V		
Nominal cap. range	10 μF to 120 μF	15 µF to	180 μF	15 µF t	ο 560 μF		
Capacitance tolerance		±20 % (120 Hz / +20 ℃)					
DC leakage current	$I \le 0.1 \text{ CV}(\mu A) [2]$	$I \le 0.1 \text{ CV}(\mu\text{A}) [2.0 \text{ V to } 6.3 \text{ V}, 2 \text{ min}], I \le 0.3 \text{ CV}(\mu\text{A}) [10 \text{ V to } 35 \text{ V}, 2 \text{ min}]$					
Dissipation factor (tan δ)		≤ 0.06 (120 Hz / + 20 °C)					
Surge voltage (V)	Rated voltage × 1	Rated voltage \times 1.25 [2.0 V to 16 V], \times 1.15 [20 V to 35 V] (15 $^{\circ}$ C to 35 $^{\circ}$ C)					
	+105 ℃ 2000 h, rated voltage applied						
	Capacitance change	Within ±20 % of the	initial value				
Endurance	Dissipation factor (tan δ)	≤ 2 times of the initial limit					
	DC leakage current	≤ 3 times of the init	ial limit : 2.0 V	′ to 6.3 V	3 V		
	DC leakage current	Within the initial limit: 10 V to 35 V					
	+60 ℃, 90 %, 500 h, No	-applied voltage					
	Capacitance change	2.0 V to 2.5 V	4.0 V, 10	0 V to 35 V	6.3 V		
Damp heat	of initial measurd value	+70 %, -20 %	+60 %	%, −20 %	+50 %, -20 %		
(Steady state)	Dissipation factor (tan δ)	≤ 2 times of the init	ial limit				
	DC lookage current	Within the initial lim	it: 2.0 V to 6.	3 V			
	DC leakage current	DC leakage current ≤ 3 times of the initial limit: 10 V to 35 V					

Marking





Characteristics list

■ 2.0 V to 6.3 V

	Rated		Case size (mm)			Specif	ication		Min.
Series	voltage (V)	Capacitance (µF)	L	W	Н	Ripple current ^{*1} (mA rms)	ESR ^{*2} (mΩ max.)	Part number	Packaging Q'ty ^{*3} (pcs)
CS	4.0	120	7.3	4.3	1.1	5100	15	EEFCS0G121R	3500
CS	6.3	68	7.3	4.3	1.1	5100	15	EEFCS0J680R	3500
СТ	4.0	180	7.3	4.3	1.4	5100	15	EEFCT0G181R	3500
	6.3	100	7.3	4.3	1.4	5100	15	EEFCT0J101R	3500
		220	7.3	4.3	1.9	5100	15	EEFCX0D221R	3500
		270	7.3	4.3	1.9	5600	12	EEFCX0D271XR	3500
	2.0	330	7.3	4.3	1.9	5100	15	EEFCX0D331R	3500
		330	7.3	4.3	1.9	5600	12	EEFCX0D331XR	3500
		390	7.3	4.3	1.9	5100	15	EEFCX0D391R	3500
		470	7.3	4.3	1.9	5100	15	EEFCX0D471R	3500
		560	7.3	4.3	1.9	5100	15	EEFCX0D561R	3500
		220	7.3	4.3	1.9	5100	15	EEFCX0E221R	3500
	2.5	330	7.3	4.3	1.9	5100	15	EEFCX0E331R	3500
		390	7.3	4.3	1.9	5100	15	EEFCX0E391R	3500
		470	7.3	4.3	1.9	5100	15	EEFCX0E471R	3500
CX		150	7.3	4.3	1.9	5100	15	EEFCX0G151R	3500
CX		180	7.3	4.3	1.9	5100	15	EEFCX0G181R	3500
		100	7.3	4.3	1.9	5600	12	EEFCX0G181XR	3500
	4.0	220	7.3	4.3	1.9	5100	15	EEFCX0G221R	3500
		220	7.3	4.3	1.9	5600	12	EEFCX0G221XR	3500
		270	7.3	4.3	1.9	5100	15	EEFCX0G271R	3500
		330	7.3	4.3	1.9	5100	15	EEFCX0G331R	3500
		100	7.3	4.3	1.9	5100	15	EEFCX0J101R	3500
		120	7.3	4.3	1.9	5100	15	EEFCX0J121R	3500
	6.3	150	7.3	4.3	1.9	5100	15	EEFCX0J151R	3500
	0.3	150	7.3	4.3	1.9	5600	12	EEFCX0J151XR	3500
		180	7.3	4.3	1.9	5100	15	EEFCX0J181R	3500
		220	7.3	4.3	1.9	5100	15	EEFCX0J221R	3500

^{*1:} Ripple current (100 kHz / +45 $^{\circ}$ C)

[◆] Please refer to each page in this catarog for "Reflow conditions" and "Taping specifications".

Temperature	coefficie	ent of ripple current		
Temperature		T ≦ 45 °C	45 °C < T ≦ 85 °C	85 °C < T ≦ 105 °C
2.0 V to 6.3 V Coefficient		1.0	0.7	0.25

[◆] Ripple current should be controlled so that surface temperature of capacitor does not exceed the category temperature.

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} Please contact us when 500 pcs packing is necessary.

Characteristics list

■ 10 V to 35 V

Not Recommended for New Design

	Rated		Case size (mm)			Specif	ication		Min.
Series	voltage (V)	Capacitance (µF)	L	W	Н	Ripple current ^{*1} (mA rms)	ESR ^{*2} (mΩ max.)	Part number	Packaging Q'ty ^{*3} (pcs)
	10	47	7.3	4.3	1.1	3200	40	EEFCS1A470R	3500
		15	7.3	4.3	1.1	3200	40	EEFCS1C150R	3500
	16	22	7.3	4.3	1.1	3200	40	EEFCS1C220R	3500
		33	7.3	4.3	1.1	3200	40	EEFCS1C330R	3500
CS		10	7.3	4.3	1.1	3200	40	EEFCS1D100R	3500
CS	20	15	7.3	4.3	1.1	3200	40	EEFCS1D150R	3500
		22	7.3	4.3	1.1	3200	40	EEFCS1D220R	3500
	25	10	7.3	4.3	1.1	3200	40	EEFCS1E100R	3500
	25	15	7.3	4.3	1.1	3200	40	EEFCS1E150R	3500
	35	10	7.3	4.3	1.1	3200	40	EEFCS1V100R	3500
	10	68	7.3	4.3	1.4	3200	40	EEFCT1A680R	3500
	16	47	7.3	4.3	1.4	3200	40	EEFCT1C470R	3500
СТ	20	33	7.3	4.3	1.4	3200	40	EEFCT1D330R	3500
Ci		47	7.3	4.3	1.4	3200	40	EEFCT1D470R	3500
	25	22	7.3	4.3	1.4	3200	40	EEFCT1E220R	3500
	35	15	7.3	4.3	1.4	3200	40	EEFCT1V150R	3500
		47	7.3	4.3	1.9	3200	40	EEFCX1A470R	3500
	10	68	7.3	4.3	1.9	3200	40	EEFCX1A680R	3500
		100	7.3	4.3	1.9	3200	40	EEFCX1A101R	3500
		15	7.3	4.3	1.9	3200	40	EEFCX1C150R	3500
		22	7.3	4.3	1.9	3200	40	EEFCX1C220R	3500
	16	33	7.3	4.3	1.9	3200	40	EEFCX1C330R	3500
		47	7.3	4.3	1.9	3200	40	EEFCX1C470R	3500
		68	7.3	4.3	1.9	3200	40	EEFCX1C680R	3500
CX		22	7.3	4.3	1.9	3200	40	EEFCX1D220R	3500
	20	33	7.3	4.3	1.9	3200	40	EEFCX1D330R	3500
	20	47	7.3	4.3	1.9	3200	40	EEFCX1D470R	3500
		56	7.3	4.3	1.9	3200	40	EEFCX1D560R	3500
		15	7.3	4.3	1.9	3200	40	EEFCX1E150R	3500
	25	22	7.3	4.3	1.9	3200	40	EEFCX1E220R	3500
		33	7.3	4.3	1.9	3200	40	EEFCX1E330R	3500
	35	15	7.3	4.3	1.9	3200	40	EEFCX1V150R	3500
	33	22	7.3	4.3	1.9	3200	40	EEFCX1V220R	3500

^{*1:} Ripple current (100 kHz / +45 $^{\circ}$ C)

[◆] Please refer to each page in this catarog for "Reflow conditions" and "Taping specifications".

	Temperature	coefficie	ent of ripple current		
	Temperature		T ≦ 45 °C	45 °C < T ≦ 85 °C	85 °C < T ≦ 105 °C
Ī	10 V to 35 V Coefficient		1.0	0.8	0.5

[•] Ripple current should be controlled so that surface temperature of capacitor does not exceed the category temperature.

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} Please contact us when 500 pcs packing is necessary.



Surface Mount Type

SX series

[Low ESR products]





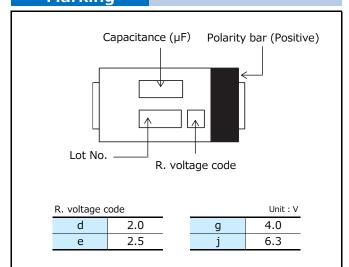


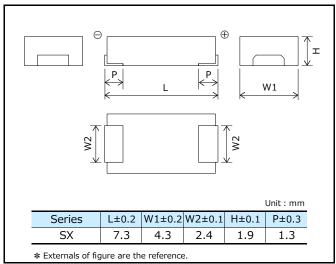
Features

- Large capacitance (560 μF max.)
- Low ESR (4.5 m Ω to 9 m Ω max.)
- High ripple current (8500 mA rms max.)
- RoHS compliance, Halogen free

Specifications							
Series		S	X				
Category temp. range		−55 °C to +105 °C					
Rated voltage range		2.0 V to 6.3 V					
Nominal cap. range		82 µF to	560 μF				
Capacitance tolerance		±20 % (120	Hz / +20 ℃)				
DC leakage current		I ≤ 0.1 CV (μ	A) 2 minutes				
Dissipation factor (tan δ)		≤ 0.06 (120 Hz / + 20 °C)					
Surge voltage (V)		Rated voltage \times 1.	25 (15 ℃ to 35 ℃)				
	+105 ℃ 2000 h, rated voltage applied						
Endurance	Capacitance change Within ±20 % of the initial value						
Endurance	Dissipation factor (tan δ)	≤ 2 times of the init	ial limit				
	DC leakage current	≤ 3 times of the init	ial limit				
	+60 ℃, 90 %, 500 h, No	-applied voltage					
Damp hoat	Capacitance change of	2.0 V to 2.5 V	4.0 V	6.3 V			
Damp heat (Steady state)	initial measurd value	+70 %, -20 %	+60 %, -20 %	+50 %, -20 %			
(Steady State)	Dissipation factor (tan δ)	≤ 2 times of the init	ial limit				
	DC leakage current	Within the initial lim	it				

Marking





	Rated		Ca	se size (m	m)	Specif	ication		Min.
Series	voltage (V)	Capacitance (µF)	L	W	Н	Ripple current ^{*1} (mA rms)	ESR ^{*2} (mΩ max.)	Part number	Packaging Q'ty*3 (pcs)
		180	7.3	4.3	1.9	6300	9	EEFSX0D181ER	3500
		220	7.3	4.3	1.9	6300	9	EEFSX0D221ER	3500
			7.3	4.3	1.9	6300	9	EEFSX0D271ER	3500
		270	7.3	4.3	1.9	7500	6	EEFSX0D271XE	3500
			7.3	4.3	1.9	8500	4.5	EEFSX0D271E4	3500
			7.3	4.3	1.9	6300	9	EEFSX0D331ER	3500
		330	7.3	4.3	1.9	7500	6	EEFSX0D331XE	3500
	2.0		7.3	4.3	1.9	8500	4.5	EEFSX0D331E4	3500
			7.3	4.3	1.9	6300	9	EEFSX0D391ER	3500
		390	7.3	4.3	1.9	7500	6	EEFSX0D391XE	3500
			7.3	4.3	1.9	8500	4.5	EEFSX0D391E4	3500
			7.3	4.3	1.9	6300	9	EEFSX0D471ER	3500
		470	7.3	4.3	1.9	7500	6	EEFSX0D471XE	3500
			7.3	4.3	1.9	8500	4.5	EEFSX0D471E4	3500
		560	7.3	4.3	1.9	8500	4.5	EEFSX0D561E4	3500
		150	7.3	4.3	1.9	6300	9	EEFSX0E151ER	3500
		180	7.3	4.3	1.9	6300	9	EEFSX0E181ER	3500
		220	7.3	4.3	1.9	6300	9	EEFSX0E221ER	3500
			7.3	4.3	1.9	7000	7	EEFSX0E221E7	3500
		270	7.3	4.3	1.9	7000	7	EEFSX0E271E7	3500
SX		330	7.3	4.3	1.9	6300	9	EEFSX0E331ER	3500
0,1	2.5		7.3	4.3	1.9	7500	6	EEFSX0E331XE	3500
			7.3	4.3	1.9	8500	4.5	EEFSX0E331E4	3500
			7.3	4.3	1.9	6300	9	EEFSX0E391ER	3500
		390	7.3	4.3	1.9	7500	6	EEFSX0E391XE	3500
			7.3	4.3	1.9	8500	4.5	EEFSX0E391E4	3500
			7.3	4.3	1.9	6300	9	EEFSX0E471ER	3500
		470	7.3	4.3	1.9	7500	6	EEFSX0E471XE	3500
			7.3	4.3	1.9	8500	4.5	EEFSX0E471E4	3500
		82	7.3	4.3	1.9	6300	9	EEFSX0G820ER	3500
		100	7.3	4.3	1.9	6300	9	EEFSX0G101ER	3500
		150	7.3	4.3	1.9	6300	9	EEFSX0G151ER	3500
			7.3	4.3	1.9	7000	7	EEFSX0G151E7	3500
	4.0	180	7.3	4.3	1.9	6300	9	EEFSX0G181ER	3500
		220	7.3	4.3	1.9	6300	9	EEFSX0G221ER	3500
		270	7.3	4.3	1.9	6300	9	EEFSX0G271ER	3500
		330	7.3	4.3	1.9	6300	9	EEFSX0G331ER	3500
			7.3	4.3	1.9	7500	6	EEFSX0G331XE	3500
		120	7.3	4.3	1.9	7000	7	EEFSX0J121E7	3500
	6.3	150	7.3	4.3	1.9	6300	9	EEFSX0J151ER	3500
		180	7.3	4.3	1.9	6300	9	EEFSX0J181ER	3500
		220	7.3	4.3	1.9	6300	9	EEFSX0J221ER	3500

^{*1:} Ripple current (100 kHz / +45 $^{\circ}$ C)

[◆] Please refer to each page in this catarog for "Reflow conditions" and "Taping specifications".

Temperature	coefficie	ent of ripple current			
Temperatu	ire	T ≦ 45 °C	45 °C < T ≦ 85 °C	85 °C < T ≦ 105 °C	
2.0 V to 6.3 V Coefficient		1.0	0.7	0.25	

[•] Ripple current should be controlled so that surface temperature of capacitor does not exceed the category temperature.

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} Please contact us when 500 pcs packing is necessary.



Surface Mount Type

GX/GX-L series

[Super low ESR products]

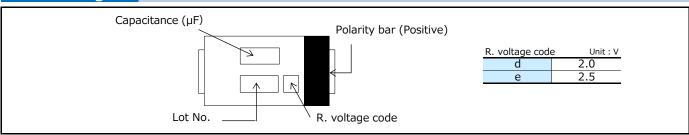


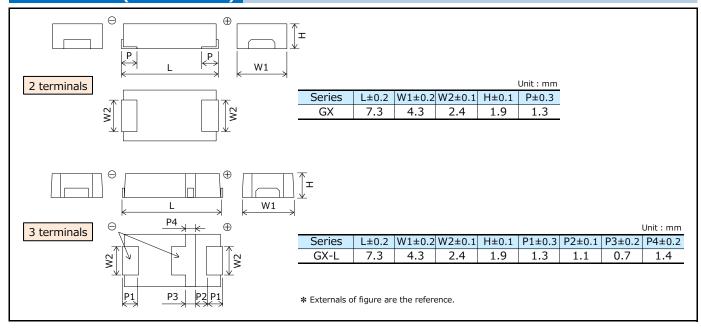
Features

- Large capacitance (560 µF max.)
- Super Low ESR (3 mΩ max.)
- Low ESL (3-terminals: 50 % less than 2-terminals) [Suffix: L]
- High ripple current (10200 mA rms max.)
- RoHS compliance, Halogen free

Specifications Series GX −55 ℃ to +105 ℃ Category temp. range 2.0 V to 2.5 V Rated voltage range 330 μF to 560 μF Nominal cap. range ±20 % (120 Hz / +20 ℃) Capacitance tolerance DC leakage current $I \le 0.1 \text{ CV } (\mu A) 2 \text{ minutes}$ Dissipation factor (tan δ) ≤ 0.06 (120 Hz / + 20 °C) Surge voltage (V) Rated voltage \times 1.25 (15 $^{\circ}$ C to 35 $^{\circ}$ C) +105 °C 2000 h, rated voltage applied Capacitance change Within ±20 % of the initial value Endurance Dissipation factor $(\tan \delta) \le 2$ times of the initial limit ≤ 3 times of the initial limit DC leakage current +60 ℃, 90 %, 500 h, No-applied voltage Capacitance change of 2.0 V to 2.5 V Damp heat +70 %, -20 % initial measurd val ue (Steady state) Dissipation factor (tan δ) ≤ 2 times of the initial limit Within the initial limit DC leakage current

Marking







	Rated		Cas	Case size (mm) Specifi		ication	The number of terminals			Min.	
Series	voltage (V)	Capacitance (µF)	L	W	н	Ripple current ^{*1} (mA rms)	ESR ^{*2} (mΩ max.)	2	3	Part number	Packaging Q'ty ^{*3} (pcs)
		330	7.3	4.3	1.9	10200	3	0		EEFGX0D331R	3500
		470	7.3	4.3	1.9	10200	3	0		EEFGX0D471R	3500
	2.0	470	7.3	4.3	1.9	10200	3		0	EEFGX0D471L	3500
GX		560	7.3	4.3	1.9	10200	3	0		EEFGX0D561R	3500
GΛ		300	7.3	4.3	1.9	10200	3		0	EEFGX0D561L	3500
		330	7.3	4.3	1.9	10200	3	0		EEFGX0E331R	3500
	2.5	470	7.3	4.3	1.9	10200	3	0		EEFGX0E471R	3500
		4/0	7.3	4.3	1.9	10200	3		0	EEFGX0E471L	3500

^{*1:} Ripple current (100 kHz / +45 $^{\circ}$ C)

[◆] Please refer to each page in this catarog for "Reflow conditions" and "Taping specifications".

Tananauatuus aasti si sut a	full market and the second	and the standard of the standa
i emperature coefficient o	Tripple current	re coefficient of ripple current

	Temperatu	re	T ≦ 45 °C	45 °C < T ≦ 85 °C	85 °C < T ≦ 105 °C
2.0 V	to 2.5 V	Coefficient	1.0	0.7	0.25

[◆] Ripple current should be controlled so that surface temperature of capacitor does not exceed the category temperature.

^{*2:} ESR (100 kHz / +20 $^{\circ}$ C)

^{*3:} Please contact us when 500 pcs packing is necessary.



Surface Mount Type

LX series

[Low ESR / Low ESL products]





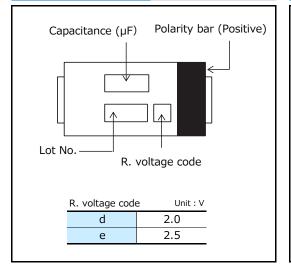
SP-Cap

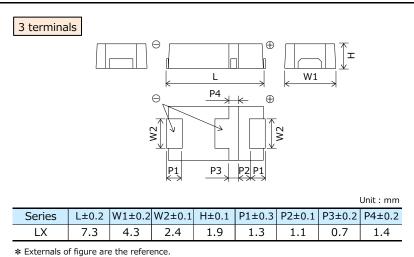
Features

- Large capacitance (560 µF max.)
- Low ESR (4.5 m Ω , 6 m Ω max.)
- Low ESL (3-terminals : 50 % less than 2-terminals)
- High ripple current (8500 mA rms max.)
- RoHS compliance, Halogen free

Specifications						
Series		LX				
Category temp. range		−55 °C to +105 °C				
Rated voltage range		2.0 V to 2.5 V				
Nominal cap. range		330 μF to 560 μF				
Capacitance tolerance		±20 % (120 Hz / +20 ℃)				
DC leakage current		I ≤ 0.1 CV (μA) 2 minutes				
Dissipation factor (tan δ)	≤ 0.06 (120 Hz / + 20 °C)					
Surge voltage (V)	Rated voltage \times 1.25 (15 $^{\circ}$ C to 35 $^{\circ}$ C)					
	+105 $^{\circ}$ C 2000 h, rated voltage applied					
Endurance	Capacitance change	Within ±20 % of the initial value				
Liluurance	Dissipation factor (tan δ)	≤ 2 times of the initial limit				
	DC leakage current	≤ 3 times of the initial limit				
	+60 ℃, 90 %, 500 h, No	-applied voltage				
Damp hoat	Capacitance change of	2.0 V to 2.5 V				
Damp heat (Steady state)	initial measurd value	+70 %, -20 %				
(Sicady state)	Dissipation factor (tan δ)	≤ 2 times of the initial limit				
	DC leakage current	Within the initial limit				

Marking







	Rated		Case size (mm)			Specif	ication		Min.
Series	voltage (V)	Capacitance (µF)	L	W	Н	Ripple current ^{*1} (mA rms)	ESR ^{*2} (mΩ max.)	Part number	Packaging Q'ty*3 (pcs)
		330	7.3	4.3	1.9	7500	6	EEFLX0D331R	3500
		330	7.3	4.3	1.9	8500	4.5	EEFLX0D331R4	3500
	2.0	470	7.3	4.3	1.9	7500	6	EEFLX0D471R	3500
	2.0	470	7.3	4.3	1.9	8500	4.5	EEFLX0D471R4	3500
LX		560	7.3	4.3	1.9	7500	6	EEFLX0D561R	3500
LX		300	7.3	4.3	1.9	8500	4.5	EEFLX0D561R4	3500
		330	7.3	4.3	1.9	7500	6	EEFLX0E331R	3500
	2.5	330	7.3	4.3	1.9	8500	4.5	EEFLX0E331R4	3500
	2.5	470	7.3	4.3	1.9	7500	6	EEFLX0E471R	3500
		470	7.3	4.3	1.9	8500	4.5	EEFLX0E471R4	3500

^{*1:} Ripple current (100 kHz / +45 ℃)

[♦] Please refer to each page in this catarog for "Reflow conditions" and "Taping specifications".

Temperature	coefficie	ent of ripple current		
Temperatu	ıre	T ≦ 45 °C	45 °C < T ≦ 85 °C	85 °C < T ≦ 105 °C
2.0 V to 2.5 V Coefficient		1.0	0.7	0.25

[◆] Ripple current should be controlled so that surface temperature of capacitor does not exceed the category temperature.

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} Please contact us when 500 pcs packing is necessary.



Surface Mount Type SR,LR,SS,LS,ST,LT series

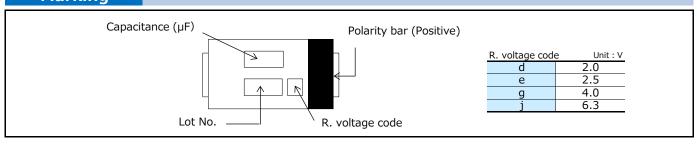


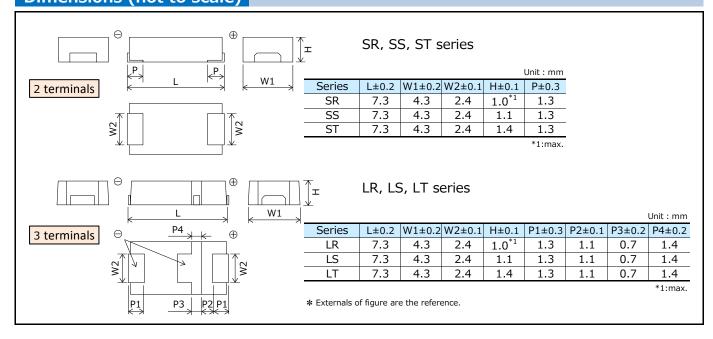
Features

- Low profile (Height 1.0 mm max.)
- Low ESR (4.5 m Ω to 9 m Ω max.)
- Low ESL (3-terminals : 50% less then 2-terminals) [LR, LS, LT series]
- High ripple current (8500 mA rms max.)
- RoHS compliance, Halogen free

Specifications								
Series	SR	LR	SS	LS	ST	LT		
Category temp. range			-55 ℃	to +105 ℃				
Rated voltage range	2.0 V	to 6.3 V		2.0 V	to 2.5 V			
Nominal cap. range	68 µF t	:o 220 μF	180 µF t	:o 220 μF	270	μF to 330 μF		
Capacitance tolerance				0 Hz / +20 ℃)				
DC leakage current				μA) 2 minutes				
Dissipation factor (tan δ)		≤ 0.06 (120 Hz / + 20 °C)						
Surge voltage (V)			Rated voltage × :	1.25 (15 ℃ to 3	5 ℃)			
	+105 ℃ 2000 h, rated voltage applied							
Endurance	Capacitance change Within ±20 % of the initial value							
Lituatance	Dissipation fac	Dissipation factor $(\tan \delta) \le 2$ times of the initial limit						
		DC leakage current ≤ 3 times of the initial limit						
			applied voltage					
Damp heat	Capacitance	change of	2.0 V to 2.5 V	4.0	V	6.3 V		
(Steady state)	initial meas		+70 %, -20 %	+60 %,	-20 %	+50 %, -20 %		
(Steauy State)	Dissipation fac	. ,	≤ 2 times of the in	itial limit				
	DC leakage	current	Within the initial lir	nit	·			

Marking







	Rated		Case	e size (r	mm)	Specif	ication	The no			Min.
Series	voltage (V)	Capacitance (µF)	L	W	Н	Ripple current ^{*1} (mA rms)	ESR ^{*2} (mΩ max.)	2	3	Part number	Packaging Q'ty ^{*3} (pcs)
	2.0	220	7.3	4.3	1.0 max.	7500	6	0		EEFSR0D221R	3500
	2.0	220	7.3	4.3	1.0 max.	8500	4.5	0		EEFSR0D221R4	3500
SR	2.5	180	7.3	4.3	1.0 max.	7500	6	0		EEFSR0E181R	3500
SK	2.5	100	7.3	4.3	1.0 max.	8500	4.5	0		EEFSR0E181R4	3500
	4.0	120	7.3	4.3	1.0 max.	6300	9	0		EEFSR0G121R	3500
	6.3	68	7.3	4.3	1.0 max.	6300	9	0		EEFSR0J680R	3500
	2.0	220	7.3	4.3	1.0 max.	7500	6		0	EEFLR0D221R	3500
	2.0	220	7.3	4.3	1.0 max.	8500	4.5		0	EEFLR0D221R4	3500
LR	2.5	180	7.3	4.3	1.0 max.	7500	6		0	EEFLR0E181R	3500
LK	2.5	100	7.3	4.3	1.0 max.	8500	4.5		0	EEFLR0E181R4	3500
	4.0	120	7.3	4.3	1.0 max.	6300	9		0	EEFLR0G121R	3500
	6.3	68	7.3	4.3	1.0 max.	6300	9		0	EEFLR0J680R	3500
SS	2.0	220	7.3	4.3	1.1	7500	6	0		EEFSS0D221R	3500
33	2.5	180	7.3	4.3	1.1	7500	6	0		EEFSS0E181R	3500
LS	2.0	220	7.3	4.3	1.1	7500	6		0	EEFLS0D221R	3500
LS	2.5	180	7.3	4.3	1.1	7500	6		0	EEFLS0E181R	3500
ST	2.0	330	7.3	4.3	1.4	7500	6	0		EEFST0D331R	3500
51	2.5	270	7.3	4.3	1.4	7500	6	0		EEFST0E271R	3500
LT	2.0	330	7.3	4.3	1.4	7500	6		0	EEFLT0D331R	3500
	2.5	270	7.3	4.3	1.4	7500	6		0	EEFLT0E271R	3500

^{*1:} Ripple current (100 kHz / +45 $^{\circ}$ C)

[◆] Please refer to each page in this catarog for "Reflow conditions" and "Taping specifications".

Temperature	coefficie	ent of ripple current			
Temperatu	ıre	T ≦ 45 °C	45 °C < T ≦ 85 °C	85 °C < T ≦ 105 °C	
2.0 V to 6.3 V Coefficient		1.0	0.7	0.25	

[◆] Ripple current should be controlled so that surface temperature of capacitor does not exceed the category temperature.

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} Please contact us when 500 pcs packing is necessary.





Surface Mount Type

GY series

[Super low ESR]





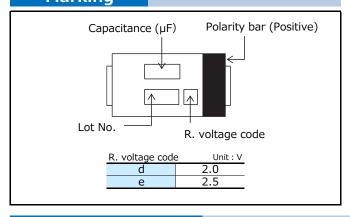


Features

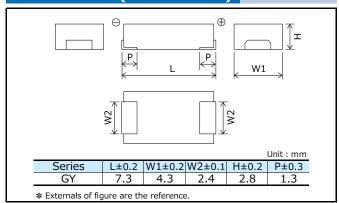
- Super low ESR (3 mΩ max.)
- Large capacitance (820 µF max.)
- High ripple current (10200 mA rms max.)
- RoHS compliance, Halogen free

Specifications					
Series		GY			
Category temp. range		-55 ℃ to +105 ℃			
Rated voltage range		2.0 V to 2.5 V			
Nominal cap. range		680 μF to 820 μF			
Capacitance tolerance		±20 % (120 Hz / +20 ℃)			
DC leakage current	$I \le 0.1 \text{ CV } (\mu A) 2 \text{ minutes}$				
Dissipation factor (tan δ)	≤ 0.06 (120 Hz / + 20 °C)				
Surge voltage (V)	Rated voltage × 1.25 (15 ℃ to 35 ℃)				
	+105 °C 2000 h, rated voltage applied				
Endurance	Capacitance change	Within ±20 % of the initial value			
Endurance	Dissipation factor $(\tan \delta)$	≤ 2 times of the initial limit			
	DC leakage current	≤ 3 times of the initial limit			
	+60 ℃, 90 %, 500 h, No	-applied voltage			
Damp heat	Capacitance change of	2.0 V to 2.5 V			
•	initial measurd value	+70 %, -20 %			
(Steady state)	Dissipation factor (tan δ)	≤ 2 times of the initial limit			
	DC leakage current	Within the initial limit			

Marking



Dimensions (not to scale)



Series	Rated voltage (V)	Capacitance (µF)	Case size (mm)			Specif	ication		Min.
			L	W	Н	Ripple current ^{*1} (mA rms)	ESR^{*2} (m Ω max.)	Part number	Packaging Q'ty (pcs)
GY	2.0	820	7.3	4.3	2.8	10200	3	EEFGY0D821R	2000
Gï	2.5	680	7.3	4.3	2.8	10200	3	EEFGY0E681R	2000

- *1: Ripple current (100 kHz / +45 ℃)
- *2: ESR (100 kHz / +20 °C)
- ◆ Please refer to each page in this catarog for "Reflow conditions" and "Taping specifications".

Temperature	coefficie	ent of ripple current		
Temperatu	ıre	T ≦ 45 °C	45 °C < T ≦ 85 °C	85 °C < T ≦ 105 °C
2.0 V to 2.5 V Coefficient		1.0	0.7	0.25

[◆] Ripple current should be controlled so that surface temperature of capacitor does not exceed the category temperature.



Surface Mount Type

CY,SY series

[Guaranteed at 85 ℃]





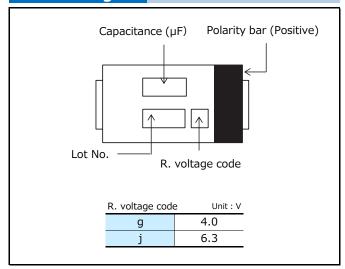


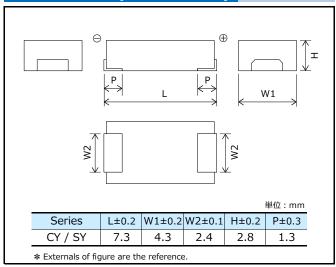
Features

- Endurance 85 °C 2000 h
- Product height (3.0 mm max.)
- High ripple current (5100 mA rms to 6300 mA rms max.)
- RoHS compliance, Halogen free

Specifications									
Series	CY / SY								
Category temp. range		−55 ℃ to +85 ℃							
Rated voltage range		4.0 V, 6.3V							
Nominal cap. range		330 μF to 470 μF							
Capacitance tolerance		±20 % (120 Hz / +20 ℃	2)						
DC leakage current		I ≤ 0.1 CV (μA) 2 minutes							
Dissipation factor (tan δ)	≤ 0.06 (120 Hz / + 20 °C)								
Surge voltage (V)	Rated voltage \times 1.25 (15 $^{\circ}$ C to 35 $^{\circ}$ C)								
	+85 ℃ 2000 h, rated voltage applied								
Endurance	Capacitance change	Within ±20 % of the initial value							
Liluurance	Dissipation factor (tan δ)	≤ 2 times of the initial limit							
	DC leakage current	≤ 3 times of the initial limit							
	+60 °C, 90 %, 500 h, No-applied voltage								
Damp hoat	Capacitance change of	4.0 V	6.3 V						
Damp heat (Steady state)	initial measurd value	+60 %, -20 %	+50 %, -20 %						
(Steady State)	Dissipation factor (tan δ)	≤ 2 times of the initial limit							
	DC leakage current	·							

Marking







	Rated		Case size (mm)			Specif	ication		Min.
Series	voltage (V)	Capacitance (µF)	L	W	Н	Ripple current ^{*1} (mA rms)	ESR ^{*2} (mΩ max.)	Part number	Packaging Q'ty*3 (pcs)
CY	4.0	470	7.3	4.3	2.8	5100	15	ECGCY0G471R	2000
CY	6.3	330	7.3	4.3	2.8	5100	15	ECGCY0J331R	2000
SY	4.0	470	7.3	4.3	2.8	6300	9	ECGSY0G471R	2000
SY	6.3	330	7.3	4.3	2.8	6300	9	ECGSY0J331R	2000

^{*1:} Ripple current (100 kHz / +45 $^{\circ}$ C)

[◆] Please refer to each page in this catarog for "Reflow conditions" and "Taping specifications".

Temperature	e coefficie	ent of ripple current			
Temperatu	ıre	T ≦ 45 °C	45 °C < T ≦ 65 °C	65 °C < T ≦ 85 °C	
4.0 V to 6.3 V Coefficient		1.0	0.7	0.25	

[•] Ripple current should be controlled so that surface temperature of capacitor does not exceed the category temperature.

^{*2:} ESR (100 kHz / +20 $^{\circ}$ C)

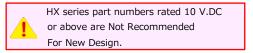
^{*3:} Please contact us when 500 pcs packing is necessary.



Surface Mount Type

HX series

[Guaranteed at 125 °C]





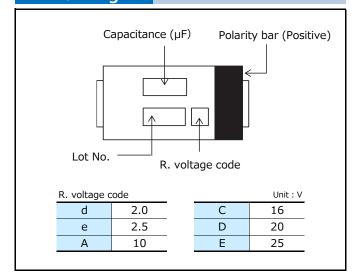


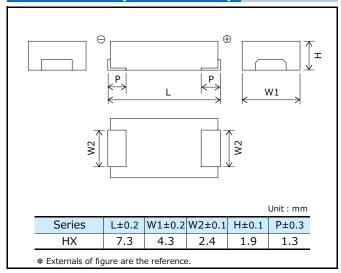
Features

- Endurance 125 °C 1000 h
- \bullet High voltage & Large capacitance (2.0 V / 560 μ F to 25 V / 33 μ F)
- Low ESR (4.5 m Ω max.)
- RoHS compliance, Halogen free

Specifications								
Series	HX							
Category temp. range		-55 ℃ to +125 ℃						
Rated voltage range		2.0 V to 2.5 V, 10 V to 25 V						
Category voltage range		1.6 V to 2.0 V, 8.0 V to 20 V	,					
Nominal cap. range		15 μF to 560 μF						
Capacitance tolerance		±20 % (120 Hz / +20 ℃)						
DC leakage current	$I \le 0.1 \text{ CV}(\mu\text{A}) [2.0 \text{ V to } 2.5 \text{ V}, 2 \text{ min}], I \le 0.3 \text{ CV}(\mu\text{A}) [10 \text{ V to } 25 \text{ V}, 2 \text{ min}]$							
Dissipation factor (tan δ)	≤ 0.1 (120 Hz / + 20 °C)							
Surge voltage (V)	Rated voltage \times 1.25 [2.0 V to 16 V], \times 1.15 [20 V to 25 V] (15 $^{\circ}$ C to 35 $^{\circ}$ C)							
	+125 $^{\circ}$ 1000 h, category voltage applied							
Endurance	Capacitance change Within ±20 % of the initial value							
Liluurance	Dissipation factor (tan δ) ≤ 2 times of the initial limit							
	DC leakage current Within the initial limit							
	After storing for 500 hou	rs at +60 °C, 90 %						
	Capacitance change	2.0 V to 2.5 V	10 V to 25 V					
Damp heat	of initial measurd value	+70 %, -20 %	+60 %, -20 %					
(Steady state)	Dissipation factor (tan δ)	≤ 2 times of the initial limit						
	DC leakage current	Within the initial limit: 2.0 V to 2.	5 V					
	DC leakage current	\leq 3 times of the initial limit : 10 V	to 25 V					

Marking





Characteristics list

■ 2.0 V to 2.5 V

	Rated	Category voltage [125 ℃] (V)	Capacitance (µF)	Case size (mm)			Specification			Min.
Series	voltage [105 ℃] (V)			L	W	н	Ripple current ^{*1} (mA rms)	ESR^{*2} (m Ω max.)	Part number	Packaging Q'ty ^{*3} (pcs)
				7.3	4.3	1.9	5100	15	EEFHX0D471R	3500
	2.0		470	7.3	4.3	1.9	6300	9	EEFHX0D471R9	3500
		1.6		7.3	4.3	1.9	7500	6	EEFHX0D471R6	3500
				7.3	4.3	1.9	8500	4.5	EEFHX0D471R4	3500
			560	7.3	4.3	1.9	5100	15	EEFHX0D561R	3500
				7.3	4.3	1.9	8500	4.5	EEFHX0D561R4	3500
НХ			330	7.3	4.3	1.9	5100	15	EEFHX0E331R	3500
ПА				7.3	4.3	1.9	6300	9	EEFHX0E331R9	3500
				7.3	4.3	1.9	7500	6	EEFHX0E331R6	3500
	2.5	2.0		7.3	4.3	1.9	8500	4.5	EEFHX0E331R4	3500
	2.5	2.0	470	7.3	4.3	1.9	5100	15	EEFHX0E471R	3500
				7.3	4.3	1.9	6300	9	EEFHX0E471R9	3500
				7.3	4.3	1.9	7500	6	EEFHX0E471R6	3500
				7.3	4.3	1.9	8500	4.5	EEFHX0E471R4	3500

■ 10 V to 25 V

Not Recommended for New Design

Series	Rated			e size (n	size (mm)		ication		Min.	
	voltage [105 ℃] (V)	voltage [125 ℃] (V)	Capacitance (µF)	L	W	Н	Ripple current*1 (mA rms)	ESR ^{*2} (mΩ max.)	Part number	Packaging Q'ty ^{*3} (pcs)
			47	7.3	4.3	1.9	3200	40	EEFHX1A470R	3500
	10	8.0	68	7.3	4.3	1.9	3200	40	EEFHX1A680R	3500
			100	7.3	4.3	1.9	3200	40	EEFHX1A101R	3500
	16	12.8	15	7.3	4.3	1.9	3200	40	EEFHX1C150R	3500
			22	7.3	4.3	1.9	3200	40	EEFHX1C220R	3500
			33	7.3	4.3	1.9	3200	40	EEFHX1C330R	3500
			47	7.3	4.3	1.9	3200	40	EEFHX1C470R	3500
HX			68	7.3	4.3	1.9	3200	40	EEFHX1C680R	3500
			22	7.3	4.3	1.9	3200	40	EEFHX1D220R	3500
	20	16	33	7.3	4.3	1.9	3200	40	EEFHX1D330R	3500
	20	10	47	7.3	4.3	1.9	3200	40	EEFHX1D470R	3500
			56	7.3	4.3	1.9	3200	40	EEFHX1D560R	3500
			15	7.3	4.3	1.9	3200	40	EEFHX1E150R	3500
	25	20	22	7.3	4.3	1.9	3200	40	EEFHX1E220R	3500
			33	7.3	4.3	1.9	3200	40	EEFHX1E330R	3500

^{*1:} Ripple current (100 kHz / +45 $^{\circ}$ C)

[◆] Please refer to each page in this catarog for "Reflow conditions" and "Taping specifications".

Temperature coefficient of ripple current										
Temperat	ure	T ≦ 45 °C	45 °C < T ≦ 85 °C	85 °C < T ≦ 105 °C	105 °C < T ≦ 125 °C					
2.0 V to 2.5 V	Coefficient	1.0	0.7	0.25	0.25					
10 V to 25 V		1.0	0.8	0.5	0.25					

[◆] Ripple current should be controlled so that surface temperature of capacitor does not exceed the category temperature.

^{*2:} ESR (100 kHz / +20 ℃)

^{*3:} Please contact us when 500 pcs packing is necessary.

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Device Solutions Business Division

Industrial Solutions Company

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